

Inventor: Min-Chih Hsuan
Serial No.: To Be Assigned Filed: Herewith
For: Flexible Multi-Chip Module and Method of Making the Same
Attorney Doc. No.: 68,700-016

1/5

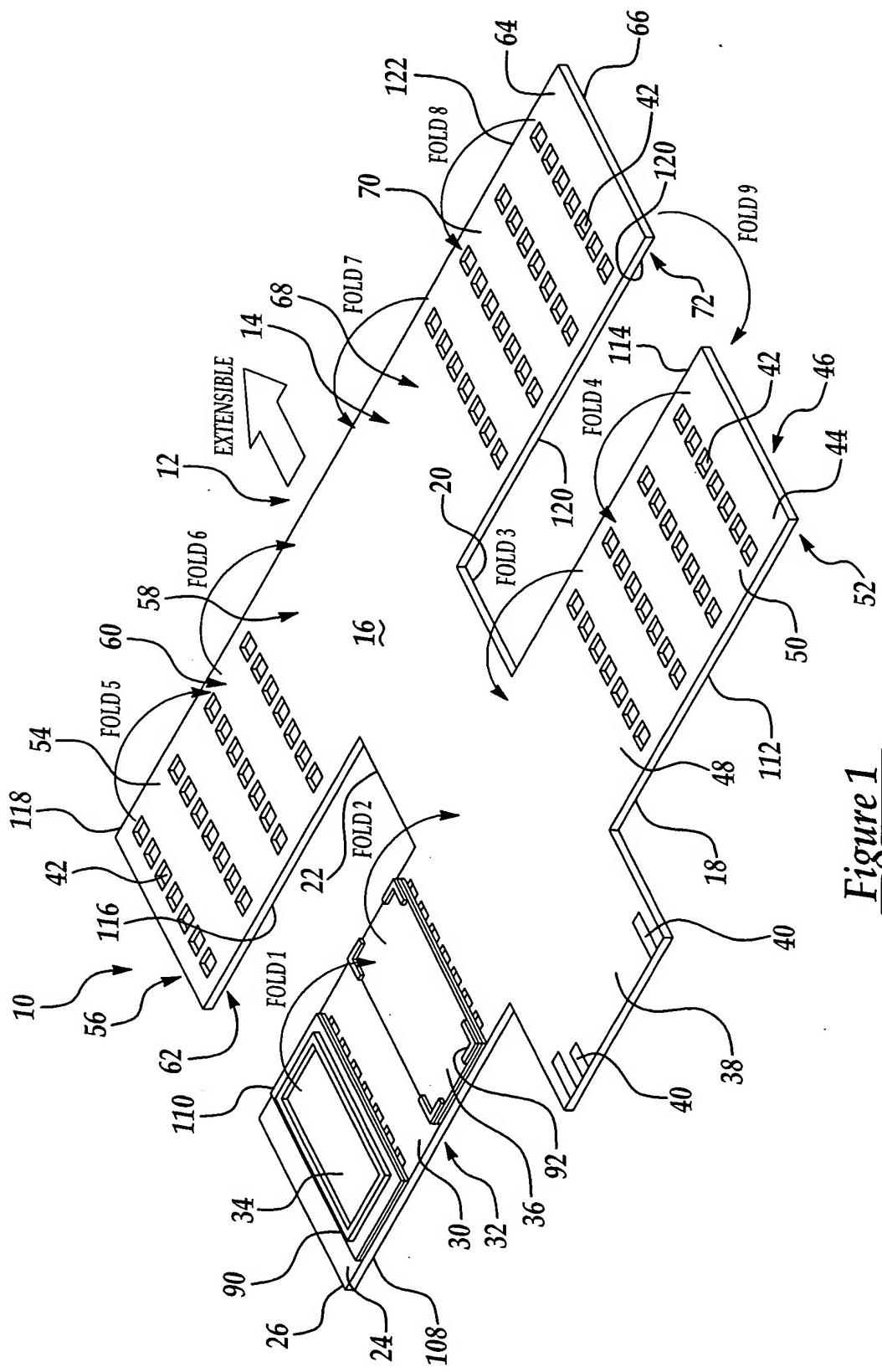


Figure 1

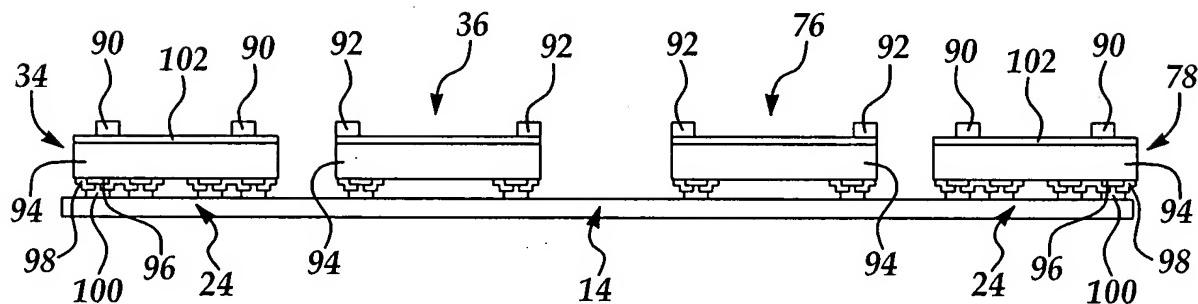
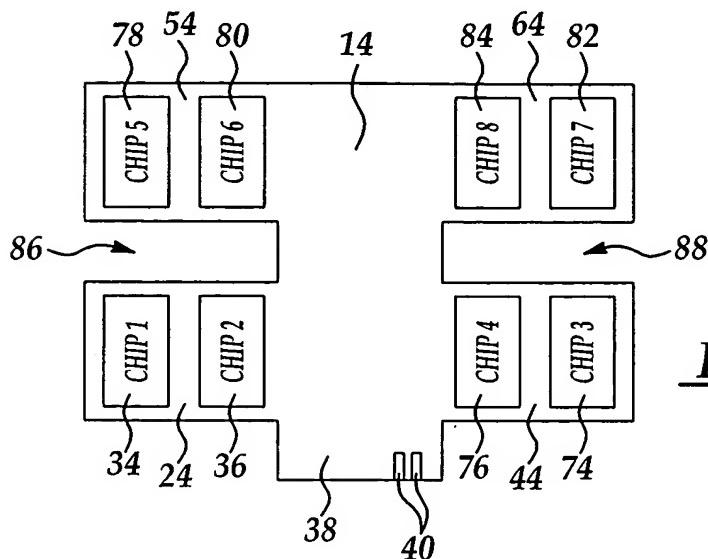


Figure 3

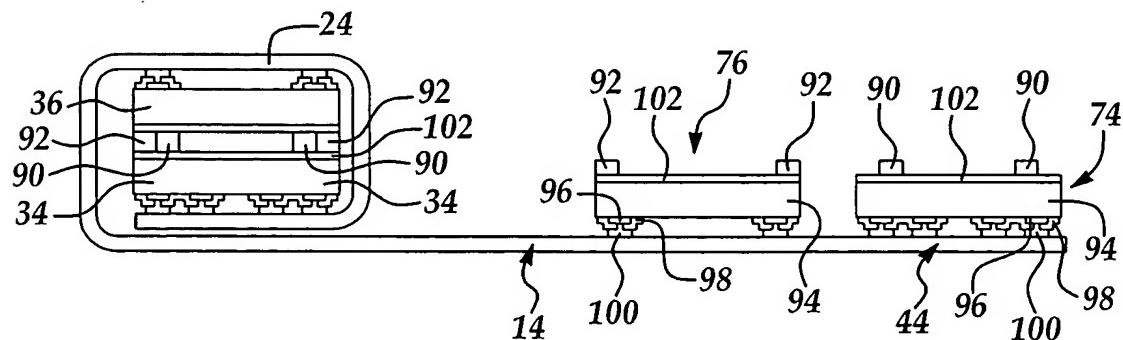
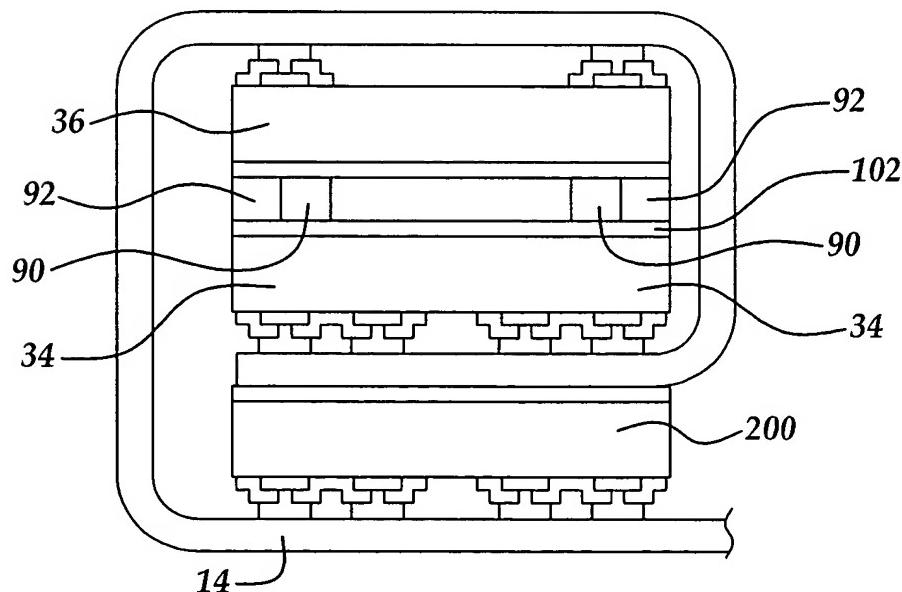
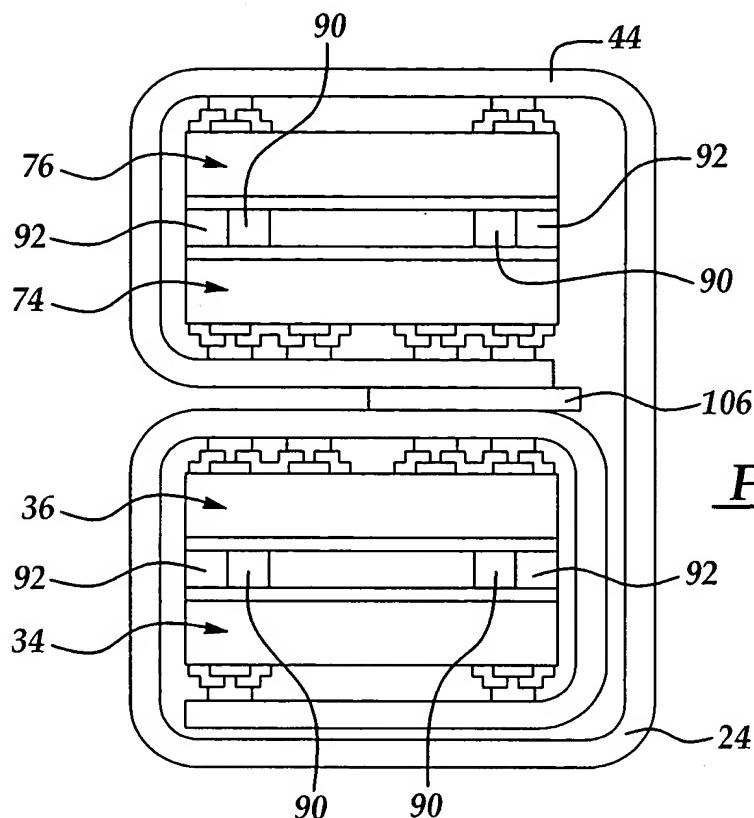


Figure 4A



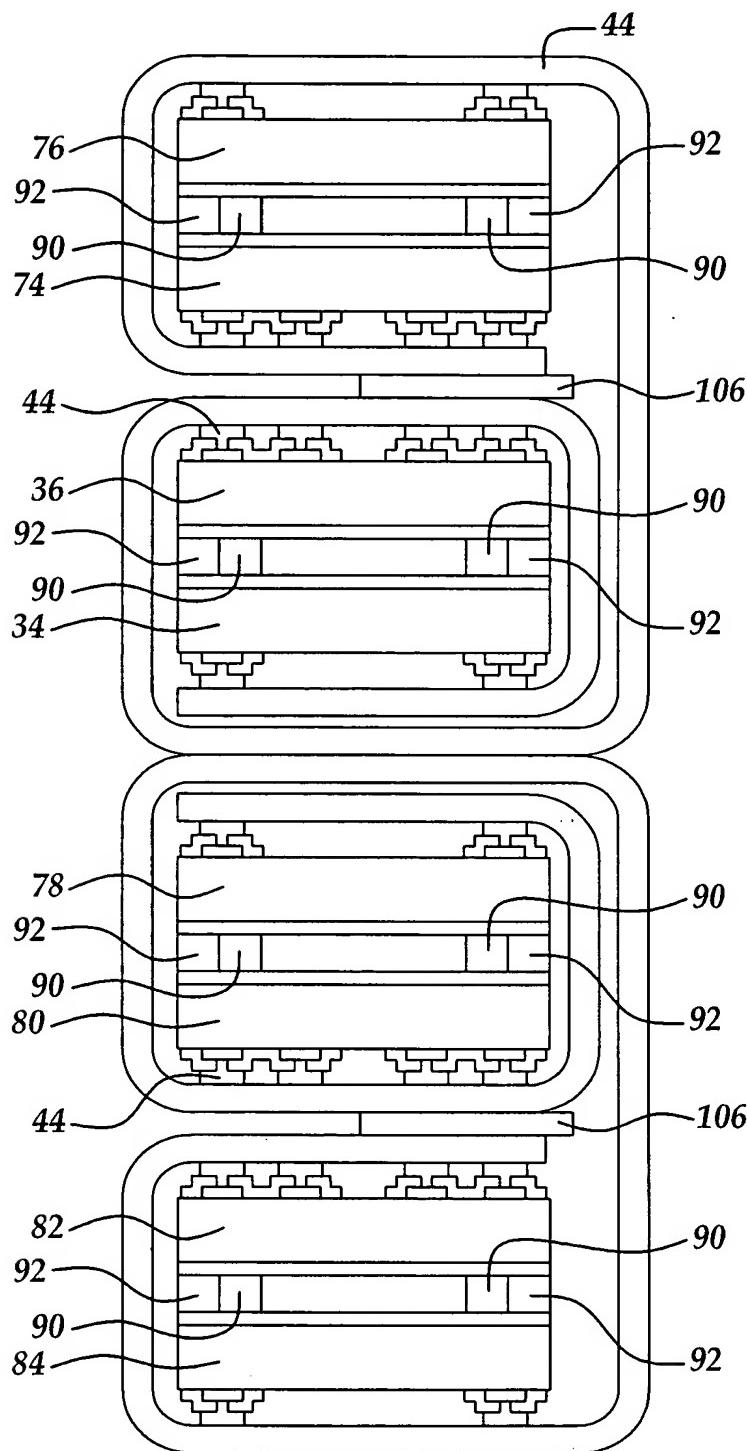


Figure 5

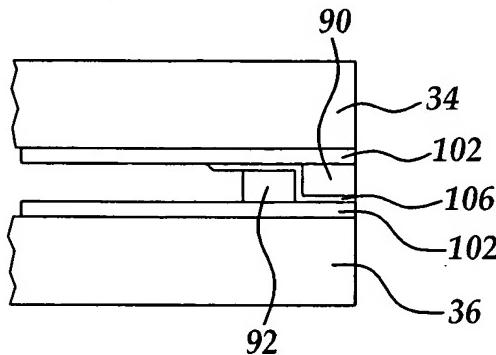


Figure 6

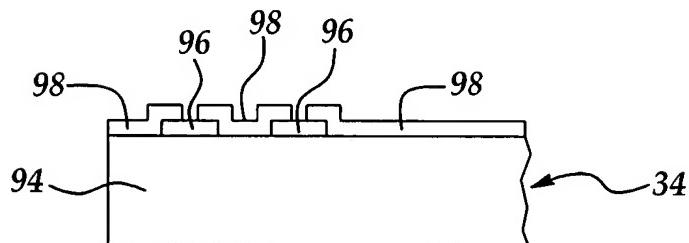


Figure 7A

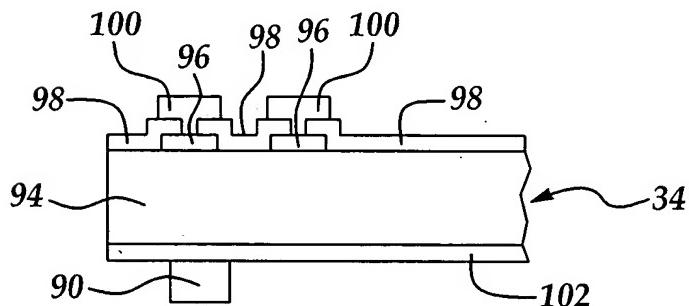


Figure 7B

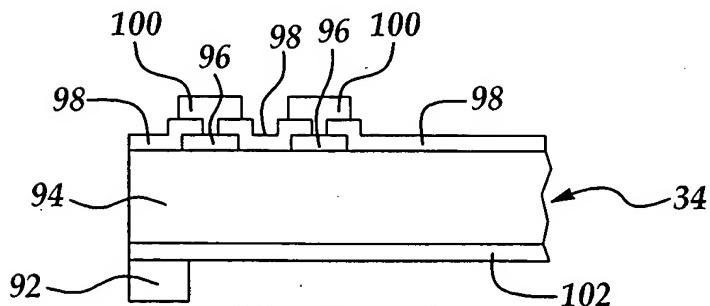


Figure 7C